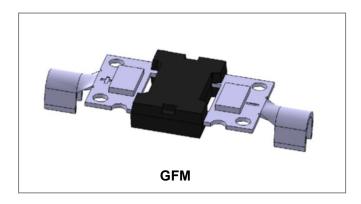






# **GF4045TS Power Schottky Module Bypass Diode**



#### **Mechanical Data**

- Case: GFM
- High temperature soldering guaranteed
  Heated-tool welding 260℃,10 seconds
- Marking Code: GF4045TS

#### **Features**

- Low thermal resistance
- Lower forward voltage drop, low power loss
- Isolate Package design, ideal for heat dispersion
- · High forward current capability
- Trench MOS Schottky technology
- Excellent anti-humidity
- Low profile package
- High forward surge capability
- All SMC parts are traceable to the wafer lot
- Additional electrical and life testing can be performed upon request

#### Maximum Ratings(limiting values, at 25 °C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	-	45	V
Average Rectified Forward Current	I <sub>F (AV)</sub>	Tc=110°C, In DC	40	Α
Peak One Cycle Non-Repetitive Surge Current	IFSM	8.3 ms, half Sine pulse	350	Α

#### **Electrical Characteristics**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V <sub>F1</sub>	@ 40A, Pulse, T <sub>J</sub> = 25 °C	0.48	0.52	V
Reverse Current*	$I_{R1}$ @ $V_R$ = rated $V_R$ $T_J$ = 25 °C		0.03	0.20	mA
	I <sub>R2</sub>	@V <sub>R</sub> = rated V <sub>R</sub> T <sub>J</sub> = 100 °C	-	12	mA
	I <sub>R3</sub>	@V <sub>R</sub> = rated V <sub>R</sub> T <sub>J</sub> = 125 °C	26	55	mA
Junction Capacitance	Ст	$@V_R = 5V, T_C = 25 ^{\circ}C$ $f_{SIG} = 1MHz$	5840	-	pF

<sup>\*</sup> Pulse width < 300 µs, duty cycle < 2%

<sup>•</sup> China - Germany - Korea - Singapore - United States •

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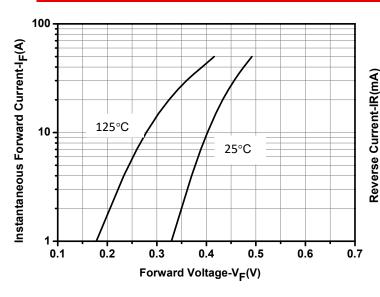




# Thermal-Mechanical Specifications(Ta=25℃ Unless otherwise specified)

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	Τ <sub>J</sub>	IN DC Forward Mode, without reverse bias, t ≤1 h	-55 to +200	°C
Storage Temperature	$T_{stg}$	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case	$R_{ heta JC}$	-	1.5	°C/W

### **Ratings and Characteristics Curves**



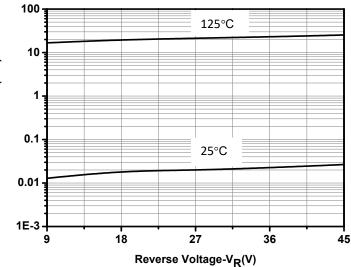


Fig.1-Typical Forward Voltage Characteristics

Fig.2-Typical Reverse Characteristics

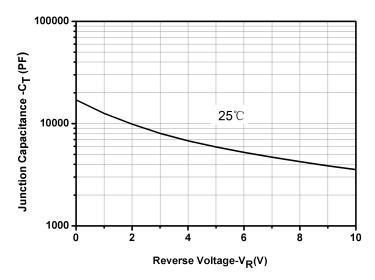


Fig.3-Capacitance vs. Reverse Voltage

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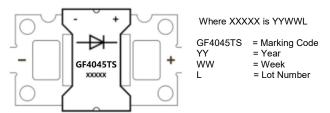




### **Ordering Information**

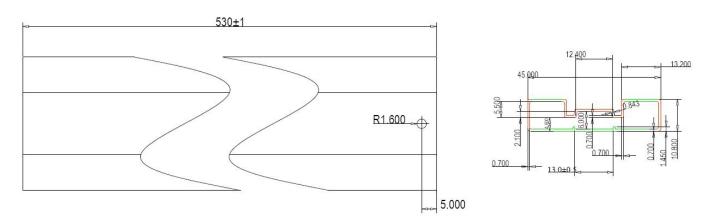
Device	Package	Shipping
GF4045TS	GFM	30pcs / Tube

## **Marking Diagram**



Order P/N	Terminals	Additional	2 0 0
GF4045TS-S1	Tin Plated	None	GF4050
GF4045TS-S2	Tin Plated	Solder Paste ⊏	Solder Pa
GF4045TS-S3	Tin Plated	Solder Block	
GF4045TS-N1	Nickel Plated	None	0 9 0
GF4045TS-N2	Nickel Plated	Solder Paste	
GF4045TS-N3	Nickel Plated	Solder Block D	Solder Blo
		•	

## **Tube Specification GFM (Millimeters)**



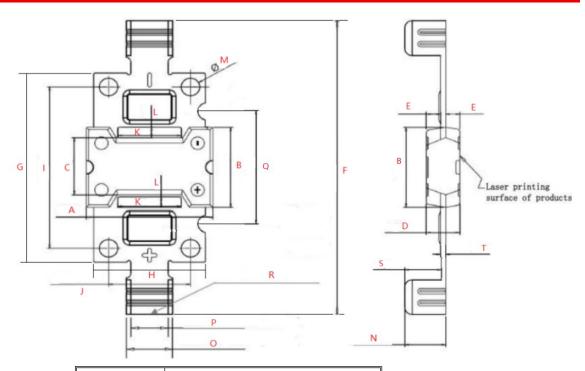
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# **Mechanical Dimensions GFM (Millimeters)**



Symbol	Dimensions in millimeters			
	Min.	Typical	Max	
Α	16.90	17.00	17.10	
В	11.38	11.48	11.58	
С	8.15	8.20	8.25	
D	4.40	4.50	4.60	
E	1.85	1.90	1.95	
F	41.90	42.00	42.10	
G	26.90	27.00	27.10	
Н	14.90	15.00	15.60	
I	22.90	23.00	23.10	
J	10.90	11.00	11.10	
K	-	8.50	-	
L	-	1.50	-	
М	-	Ø 2.50	2.55	
N	5.35	5.50	5.65	
0	6.20	6.30	6.40	
Р	4.90	5.00	5.10	
Q	15.95	16.00	16.05	
R	2.80	2.90	3.00	
S	4.75	4.80	4.85	
Т	0.67	0.70	0.73	

Dimension H includes Burrs/cutting residuals.

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